



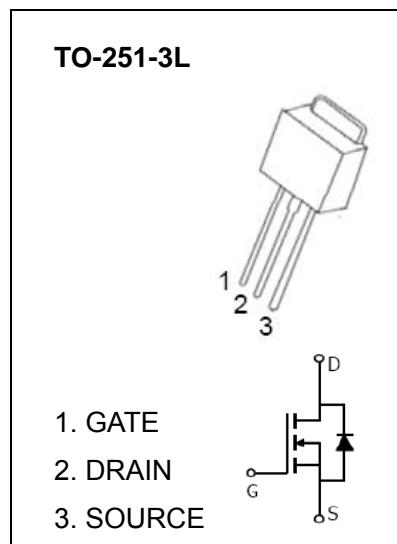
JIANGSU CHANGJIANG ELECTRONICS TECHNOLOGY CO., LTD

## TO-251-3L Plastic-Encapsulate MOSFETS

### CJD02N60 N-Channel Power MOSFET

#### General Description

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.



#### FEATURE

- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- $I_{DSS}$  and  $V_{DS(on)}$  Specified at Elevated Temperature

#### Maximum ratings ( $T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter                                   | Symbol          | Value     | Unit                      |
|---|-----------------|-----------|---------------------------|
| Drain-Source Voltage                        | $V_{DS}$        | 600       | V                         |
| Gate-Source Voltage                         | $V_{GS}$        | $\pm 20$  |                           |
| Continuous Drain Current                    | $I_D$           | 2         | A                         |
| Pulsed Drain Current                        | $I_{DM}$        | 8         |                           |
| Single Pulsed Avalanche Energy*             | $E_{AS}$        | 128       | mJ                        |
| Power Dissipation                           | $P_D$           | 1.25      | W                         |
| Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 100       | $^\circ\text{C}/\text{W}$ |
| Junction Temperature                        | $T_J$           | 150       | $^\circ\text{C}$          |
| Storage Temperature                         | $T_{stg}$       | -50 ~+150 |                           |

\* $E_{AS}$  condition:  $T_J=25^\circ\text{C}$ ,  $V_{DD}=50\text{V}$ ,  $L=64\text{mH}$ ,  $I_{AS}=2\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

**Electrical characteristics ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

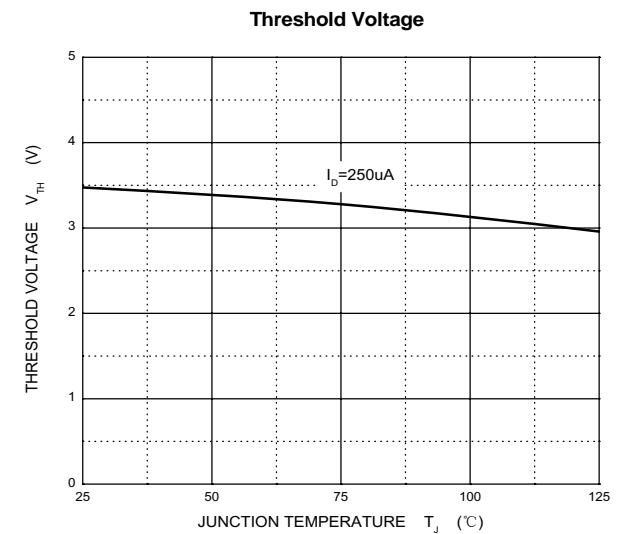
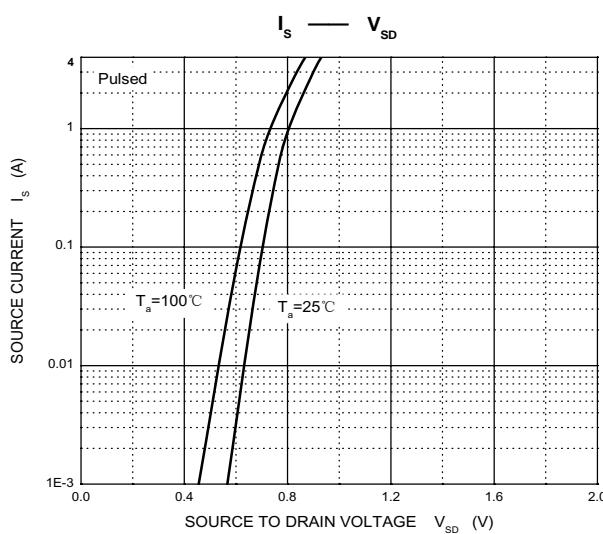
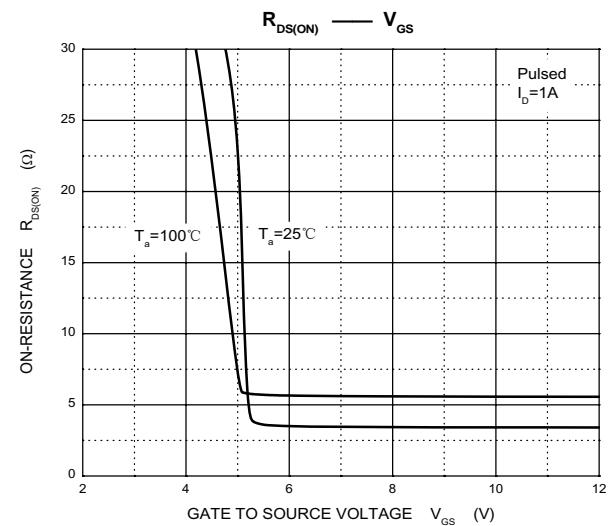
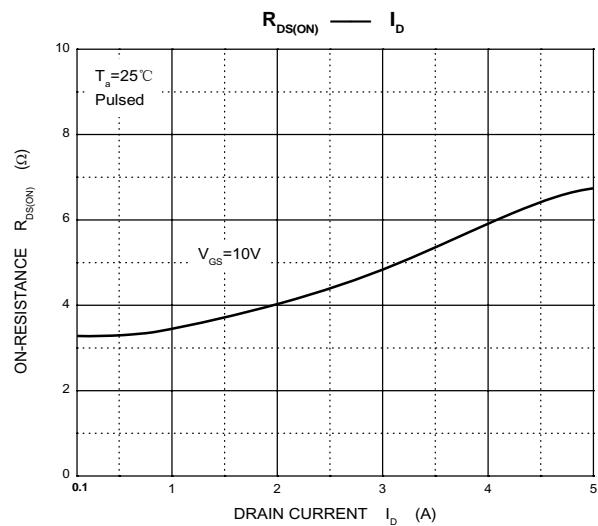
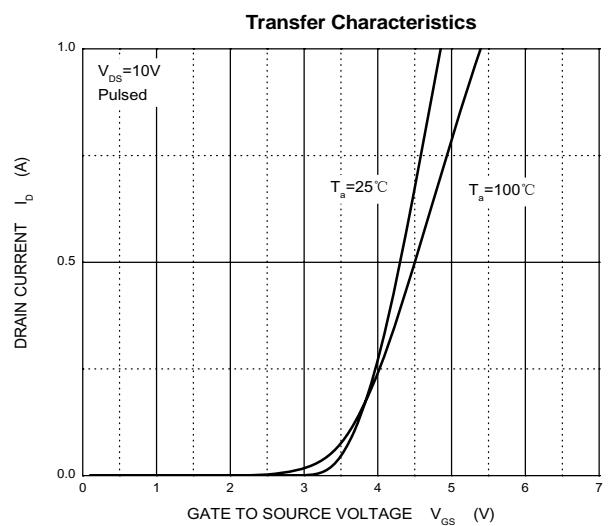
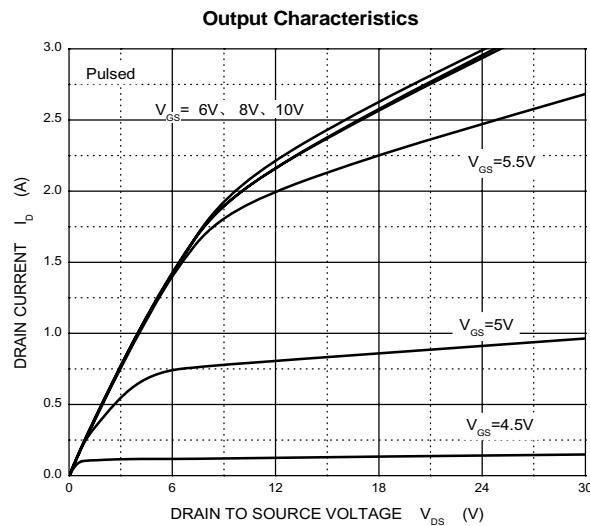
| Parameter                                     | Symbol                      | Test Condition  | Min | Typ | Max       | Unit          |
|---|-----------------------------|---|-----|-----|-----------|---------------|
| <b>Off characteristics</b>                    |                             |   |     |     |           |               |
| Drain-source breakdown voltage                | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$                     | 600 |     |           | V             |
| Zero gate voltage drain current               | $I_{DSS}$                   | $V_{DS} = 600V, V_{GS} = 0V$                            |     |     | 25        | $\mu\text{A}$ |
|   |                             | $V_{DS} = 480V, V_{GS} = 0V, T_j = 125^\circ\text{C}$   |     |     | 100       |               |
| Gate-body leakage current                     | $I_{GSS}$                   | $V_{DS} = 0V, V_{GS} = \pm 20V$                         |     |     | $\pm 100$ | nA            |
| <b>On characteristics (note1)</b>             |                             |   |     |     |           |               |
| Gate-threshold voltage                        | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                 | 2.0 |     | 4.0       | V             |
| Static drain-source on-resistance             | $R_{DS(\text{on})}$         | $V_{GS} = 10V, I_D = 1A$                                |     | 3.6 | 4.4       | $\Omega$      |
| Forward transconductance                      | $g_{fs}$                    | $V_{DS} = 50V, I_D = 1A$                                | 1   |     |           | S             |
| <b>Dynamic characteristics (note 2)</b>       |                             |   |     |     |           |               |
| Input capacitance                             | $C_{iss}$                   | $V_{DS} = 25V, V_{GS} = 0V, f = 1\text{MHz}$            |     | 435 |           | pF            |
| Output capacitance                            | $C_{oss}$                   |   |     | 56  |           |               |
| Reverse transfer capacitance                  | $C_{rss}$                   |   |     | 9.2 |           |               |
| <b>Switching characteristics (note 2)</b>     |                             |   |     |     |           |               |
| Total gate charge                             | $Q_g$                       | $V_{DS} = 480V, V_{GS} = 10V, I_D = 2.4A$               |     | 40  | 50        | nC            |
| Gate-source charge                            | $Q_{gs}$                    |   |     | 4.2 |           |               |
| Gate-drain charge                             | $Q_{gd}$                    |   |     | 8.4 |           |               |
| Turn-on delay time                            | $t_{d(on)}$                 | $V_{DD} = 300V, I_D = 2A, V_{GS} = 10V, R_G = 18\Omega$ |     | 12  |           | ns            |
| Turn-on rise time                             | $t_r$                       |   |     | 21  |           |               |
| Turn-off delay time                           | $t_{d(off)}$                |   |     | 30  |           |               |
| Turn-off fall time                            | $t_f$                       |   |     | 24  |           |               |
| <b>Drain-Source Diode Characteristics</b>     |                             |   |     |     |           |               |
| Drain-source diode forward voltage(note1)     | $V_{SD}$                    | $V_{GS} = 0V, I_S = 2A$                                 |     |     | 1.6       | V             |
| Continuous drain-source diode forward current | $I_S$                       |   |     |     | 2         | A             |
| Pulsed drain-source diode forward current     | $I_{SM}$                    |   |     |     | 8         | A             |

Notes:

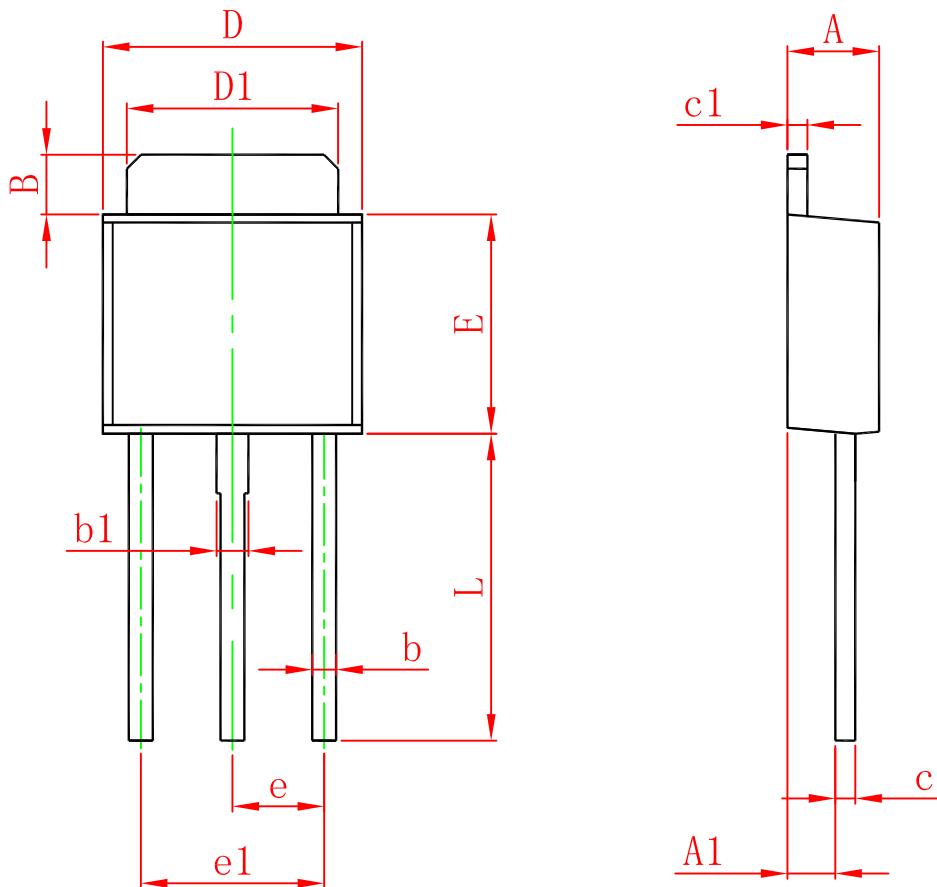
1. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
2. Guaranteed by design, not subject to production.

# Typical Characteristics

**CJD02N60**



## TO-251-3L Package Outline Dimensions



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 2.200                     | 2.400 | 0.087                | 0.094 |
| A1     | 1.050                     | 1.350 | 0.042                | 0.054 |
| B      | 1.350                     | 1.650 | 0.053                | 0.065 |
| b      | 0.500                     | 0.700 | 0.020                | 0.028 |
| b1     | 0.700                     | 0.900 | 0.028                | 0.035 |
| c      | 0.430                     | 0.580 | 0.017                | 0.023 |
| c1     | 0.430                     | 0.580 | 0.017                | 0.023 |
| D      | 6.350                     | 6.650 | 0.250                | 0.262 |
| D1     | 5.200                     | 5.400 | 0.205                | 0.213 |
| E      | 5.400                     | 5.700 | 0.213                | 0.224 |
| e      | 2.300 TYP.                |       | 0.091 TYP.           |       |
| e1     | 4.500                     | 4.700 | 0.177                | 0.185 |
| L      | 7.500                     | 7.900 | 0.295                | 0.311 |